

Am79M570/Am79M574

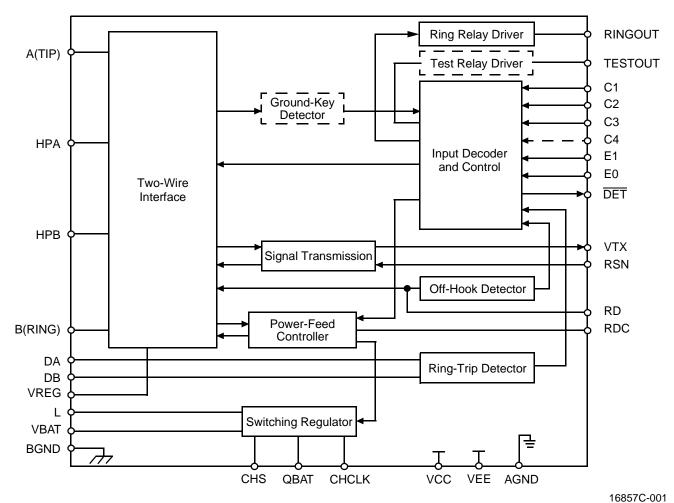
Metering Subscriber Line Interface Circuit

DISTINCTIVE CHARACTERISTICS

- Programmable constant-resistance feed
- Programmable loop-detect threshold
- **■** Ground-key detect
- Performs polarity reversal
- Line-feed characteristics independent of battery variations
- Test relay driver optional

- Supports 2.2 Vrms metering (12 and 16 kHz)
- On-chip switching regulator for low-power dissipation
- Two-wire impedance set by single external impedance
- Tip Open state for ground-start lines
- On-hook transmission

BLOCK DIAGRAM



Notes:

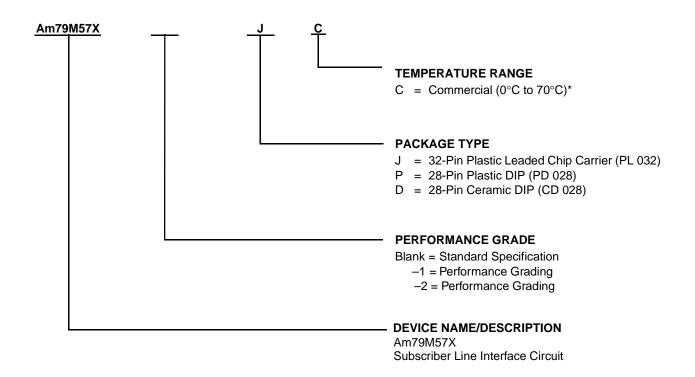
- 1. Am79M570—E0 and E1 inputs; ring relay driver sourced internally to BGND.
- 2. Am79M574—E0 and E1 inputs; ring and test relay drivers sourced internally to BGND.
- 3. Current gain $(K_1) = 1000$ for both parts.

Publication# 16857 Rev: D Amendment: /0 Issue Date: July 1998

ORDERING INFORMATION

Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the elements below.



Valid Combinations						
	,	DC				
Am79M57X	_1 _2	JC				
	_	PC				

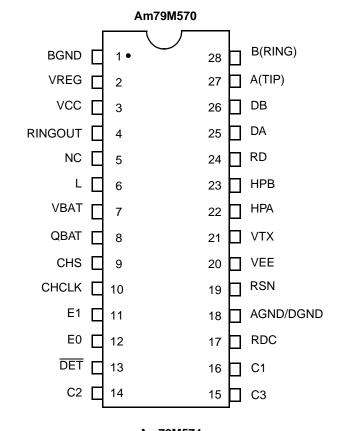
Valid Combinations

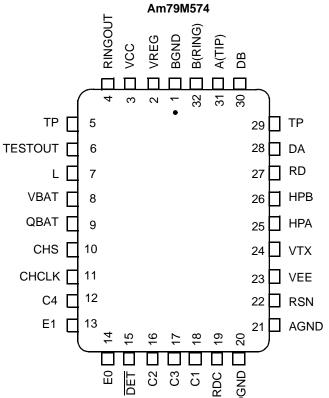
Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

Note:

* Functionality of the device from 0°C to +70°C is guaranteed by production testing. Performance from –40°C to +85°C is guaranteed by characterization and periodic sampling of production units.

CONNECTION DIAGRAMS Top View





Notes:

- 1. Pin 1 is marked for orientation.
- 2. TP is a thermal conduction pin tied to substrate (QBAT).
- 3. NC = No connect

PIN DESCRIPTIONS

Pin Names	Type	Description
AGND	Gnd	(Am79M574) Analog (quiet) ground.
AGND/DGND	Gnd	(Am79M570) Analog and Digital ground are connected internally to a single pin.
A(TIP)	Output	Output of A(TIP) power amplifier.
BGND	Gnd	Battery (power) ground.
B(RING)	Output	Output of B(RING) power amplifier.
C3-C1	Inputs	Decoder. TTL compatible. C3 is MSB and C1 is LSB.
C4	Input	(Am79M574) Test relay driver command. TTL compatible. A logic Low enables the driver
CHCLK	Input	Chopper clock. Input to switching regulator (TTL compatible). Frequency = 256 kHz (nominal).
CHS	Input	Chopper Stabilization. Connection for external stabilization components.
DA	Input	Ring-trip negative. Negative input to ring-trip comparator.
DB	Input	Ring-trip positive. Positive input to ring-trip comparator.
DET	Output	Detector. Logic Low indicates that the selected detector is tripped. Logic inputs C3–C1, E1, and E0 select the detector. Open-collector with a built-in 15 k Ω pull-up resistor.
DGND	Gnd	(Am79M574) Digital ground.
E0	Input	A logic High enables $\overline{\text{DET}}$. A logic Low disables $\overline{\text{DET}}$.
E1	Input	E1 = High connects the ground-key detector to \overline{DET} , and E1 = Low connects the off-hool or ring-trip detector to \overline{DET} .
HPA	Capacitor	High-pass filter capacitor; A(TIP) side of high-pass filter capacitor.
HPB	Capacitor	High-pass filter capacitor; B(RING) side of high-pass filter capacitor.
L	Input	Switching Regulator Power Transistor. Connection point for filter inductor and anode of catch diode. Has up to 60 V of pulse waveform and must be isolated from sensitive circuits. Keep the diode connections short because of the high currents and high di/dt.
QBAT	Battery	Quiet Battery. Filtered battery supply for the signal processing circuits.
RD	Resistor	Detector resistor. Threshold modification/filter point for the off-hook detector.
RDC	Resistor	DC feed resistor. Connection point for the DC feed current programming network, which also connects to the receiver summing node (RSN). V _{RDC} is negative for normal polarity and positive for reverse polarity.
RINGOUT	Output	Ring relay driver. Sourcing from BGND with internal diode to QBAT.
RSN	Input	The metallic current (AC and DC) between A(TIP) and B(RING) = 1000 x the current into this pin. The networks that program receive gain, two-wire impedance, and feed curren all connect to this node.
TESTOUT	Output	Test relay driver. Sourcing from BGND with internal diode to QBAT.
TMG	_	Thermal management. External resistor this pin and VBAT to off-load power dissipation from SLIC. Functions during Normal Polarity and Reverse Polarity states.
TP	Thermal	Thermal pin. Connection for heat dissipation. Internally connected to substrate (QBAT) Leave as open circuit or connected to QBAT. In both cases, the TP pins can connect to an area of copper on the board to enhance heat dissipation
VBAT	Battery	Battery supply. Connected through an external protection diode.
VCC	Power	+5 V power supply.
VEE	Power	−5 V power supply.
VREG	Input	Regulated Voltage. Provides negative power supply for power amplifiers, connection point for inductor, filter capacitor, and chopper stabilization.
VTX	Output	Transmit Audio. This output is 0.510 times the A(TIP) and B(RING) metallic voltage. The other end of the two-wire input impedance programming network connects here.

ABSOLUTE MAXIMUM RATINGS

Storage temperature55°C to +150°C
V _{CC} with respect to AGND/DGND0.4 V to +7.0 V
V _{FF} with respect to AGND/DGND +0.4 V to -7.0 V
V _{BAT} with respect to AGND/DGND +0.4 V to -70 V
5
Note: Rise time of V_{BAT} (dv/dt) must be limited to 27 V/ μ s or less when Q_{BAT} bypass = 0.33 μ F.
BGND with respect to AGND/DGND +1.0 V to -3.0 V
A(TIP) or B(RING) to BGND:
Continuous
10 ms (f = 0.1 Hz)70 V to +5.0 V
1 μ s (f = 0.1 Hz)
250 ns (f = 0.1 Hz)120 V to +15 V
Current from A(TIP) or B(RING)±150 mA
Voltage on RINGOUT BGND to 70 V above Q_{BAT}
Voltage on TESTOUT BGND to 70 V above Q_{BAT}
Current through relay drivers 60 mA
Voltage on ring-trip inputs
(DA and DB) V _{BAT} to 0 V
Current into ring-trip inputs ±10 mA
Peak current into regulator
switch (L pin)
Switcher transient peak off
voltage on L pin +1.0 V
C4–C1, E0, E1, CHCLK to AGND/DGND0.4 V to V _{CC} + 0.4 V
$\label{eq:maximum power dissipation, (see note)} \begin{array}{ll} \text{Maximum power dissipation, (see note)}. & T_{A} = 70^{\circ}\text{C} \\ \text{In 28-pin ceramic DIP package}. & 2.58 W \\ \text{In 28-pin plastic DIP package}. & 1.4 W \\ \text{In 32-pin PLCC package}. & 1.74 W \\ \end{array}$

Note: Thermal limiting circuitry on chip will shut down the circuit at a junction temperature of about 165°C. The device should never be exposed to this temperature. Operation above 145°C junction temperature may degrade device reliability. See the SLIC Packaging Considerations for more information.

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability.

OPERATING RANGES

Commercial (C) Devices

Ambient temperature0°C to +70°C
V _{CC} 4.75 V to 5.25 V
V _{EE}
$V_{BAT}40 V$ to –58 V
AGND/DGND 0 V
BGND with respect to AGND/DGND100 mV to +100 mV
Load resistance on VTX to ground 10 $k\Omega$ min

Operating Ranges define those limits between which the functionality of the device is guaranteed.

^{*} Functionality of the device from 0°C to +70°C is guaranteed by production testing. Performance from -40°C to +85°C is guaranteed by characterization and periodic sampling of production units.

ELECTRICAL CHARACTERISTICS

Description	Test Conditions (See Note 1)	Min	Тур	Max	Unit	Note
Analog (V _{TX}) output impedance	е			3		Ω	
Analog (V _{TX}) output offset	0°C to +70°C -40°C to +85°C	-1* -1	-35 -30 -40 -35		+35 +30 +40 +35	mV	 4 4
Analog (RSN) input impedance Longitudinal impedance at A o				1	20 35	Ω	4
Overload level $Z_{2WIN} = 600 \Omega$ to 900Ω	4-wire 2-wire		-3.1 -6.0		+3.1 +6.0	Vpk	_ 2
Transmission Performance,	2-Wire Impedance				•		
2-wire return loss (See Test Circuit D)	300 Hz to 500 Hz 500 Hz to 2500 Hz 2500 Hz to 3400 Hz		26 26 20			dB	4, 14
Longitudinal Balance (2-Wire	e and 4-Wire, See Test Circuit C)				•	•	
$R_L = 600 \Omega$, longitudinal to metallic L-T, L-4 (normalized to unity gain)	300 Hz to 3400 Hz	-1*	48 52				
Longitudinal to metallic L-T, L-	4 200 Hz to 1 kHz normal polarity 0°C to +70°C normal polarity -40°C to +85°C reverse polarity	-2* -2 -2	63 58 54			dB	_ _ 4 _
	1 kHz to 3.4 kHz normal polarity 0°C to +70°C normal polarity -40°C to +85°C reverse polarity	-2* -2 -2	58 54 54				_ _ 4 _
Longitudinal signal generation 4-L	300 Hz to 800 Hz 300 Hz to 800 Hz	-1*	40 42				
Longitudinal current capability per wire	Active state OHT state			25 18		mArms	4
Insertion Loss (2- to 4-Wire	and 4- to 2-Wire, See Test Circuits A a	and B)			•		
Gain accuracy 2- to 4-wire	0 dBm, 1 kHz, 0°C to +70°C 0 dBm, 1 kHz, -40°C to +85°C 0 dBm, 1 kHz, 0°C to +70°C 0 dBm, 1 kHz, -40°C to +85°C	-1* -1	5.75 5.65 5.75 5.70	5.85 5.85 5.85 5.85	6.00 6.05 5.95 6.00		
4- to 2-wire 4- to 2-wire 4- to 2-wire 4- to 2-wire	0 dBm, 1 kHz, 0°C to +70°C 0 dBm, 1 kHz, -40°C to +85°C 0 dBm, 1 kHz, 0°C to +70°C 0 dBm, 1 kHz, -40°C to +85°C	-1* -1	-0.15 -0.20 -0.1 -0.15		+0.15 +0.20 +0.1 +0.15	dB	
Variation with frequency	300 Hz to 3400 Hz Relative to 1 kHz 0°C to +70°C -40°C to +85°C		-0.1 -0.15		+0.1 +0.15		_ _ _ 4
Gain tracking	+7 dBm to -55 dBm, ref 0 dBm 0°C to +70°C -40°C to +85°C		-0.1 -0.15		+0.1 +0.15		4 4

Notes:

^{*} P.G. = Performance Grade

^{−2} grade performance parameters are equivalent to −1 performance parameters except where indicated.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Description	Test Conditions (See Note 1)	Min	Тур	Max	Unit	Note
Balance Return Signal (4- to 4-V	Vire, See Test Circuit B)	•	•			
Gain accuracy	0 dBm, 1 kHz, 0°C to +70°C 0 dBm, 1 kHz, -40°C to +85°C 0 dBm, 1 kHz, 0°C to +70°C -1* 0 dBm, 1 kHz, -40°C to +85°C -1	-6.00 -6.05 -5.95 -6.00	-5.85 -5.85 -5.85 -5.85	-5.75 -5.65 -5.75 -5.70		3 3, 4 3 3, 4
Variation with frequency	300 Hz to 3400 Hz Relative to 1 kHz 0°C to +70°C -40°C to +85°C	-0.1 -0.15		+0.1 +0.15	dB	 3, 4 3, 4
Gain tracking	+7 dBm to -55 dBm, ref 0 dBm 0°C to +70°C -40°C to +85°C	-0.1 -0.15		+0.1 +0.15		4 4
Group delay	f = 1 kHz		5.3		μs	4, 15
Total Harmonic Distortion (2- to	4-Wire or 4- to 2-Wire, See Test Circuit	s A and B)	l		l	ı
Total harmonic distortion	0 dBm, 300 Hz to 3.4 kHz +9 dBm, 300 Hz to 3.4 kHz		-64 -55	-50 -40	dB	
Total harmonic distortion with metering				-35	uВ	4, 11
Idle Channel Noise						•
C-message weighted noise	2-wire, 0°C to +70°C 2-wire, 0°C to +70°C 2-wire, -40°C to +85°C		+7 +7 +7	+15 +12 +15	dBrnC	4
	4-wire, 0°C to +70°C 4-wire, 0°C to +70°C 4-wire, -40°C to +85°C		+7 +7 +7	+15 +12 +15	JUBING	4
Psophometric weighted noise	2-wire, 0°C to +70°C 2-wire, 0°C to +70°C 2-wire, -40°C to +85°C		-83 -83 -83	-75 -78 -75	dBmp	7 7 4, 7
	4-wire, 0°C to +70°C 4-wire, 0°C to +70°C 4-wire, -40°C to +85°C		-83 -83 -83	-75 -78 -75	автр	7 7 4, 7
Single Frequency Out-of-Band	Noise (See Test Circuit E)					
Metallic	4 kHz to 9 kHz 9 kHz to 1 MHz 256 kHz and harmonics		–76 –76 –57		dBm	4, 5, 9 4, 5, 9 4, 5
Longitudinal	1 kHz to 15 kHz Above 15 kHz 256 kHz and harmonics		-70 -85 -57		dbiii	4, 5, 9 4, 5, 9 4, 5
Line Characteristics (See Figure	e 1) BAT = –48 V, R _L = 600 Ω and 900 Ω ,	R _{FEED} = 80	0 Ω	1		I.
Apparent battery voltage	Active state	47	50	53	V	
Loop-current accuracy	Active state	-7.5		+7.5		
Loop current—Tip Open state	$R_L = 600 \Omega$			1.0		
Loop current—Open Circuit state	$R_L = 0 \Omega$			1.0	%	
Loop-current limit accuracy	OHT state Active state	-20		+20		10
Fault current limit, I _L LIM (I _{AX} + I _{BX})	A and B shorted to GND			130	mA	

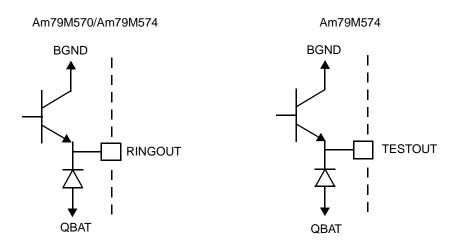
ELECTRICAL CHARACTERISTICS (CONTINUED)

Description	Test Conditions (See Note 1	1)	Min	Тур	Max	Unit	Note
Power Dissipation BAT = -48 \	V, Normal Polarity	•			•		,
On-hook Open Circuit state		-1*		35 35	120 80		
On-hook OHT state		-1*		135 135	250 200	,,,	
On-hook Active state		-1*		200 200	400 300	mW =	
Off-hook OHT state	$R_L = 600 \Omega$			500	750		
Off-hook Active state	$R_L = 600 \Omega$			650	1000		
Supply Currents							
V_{CC} On-hook supply current V_{EE} On-hook supply current	Open Circuit state OHT state Active state Open Circuit state			3.0 6.0 7.5	4.5 10.0 12.0 2.3		
	OHT state Active state			2.2 2.7	3.5 6.0	mA	
V _{BAT} On-hook supply current	Open Circuit state OHT state Active state			0.4 3.0 4.0	1.0 5.0 6.0		
Power Supply Rejection Ratio	(V _{RIPPLE} = 50 mVrms)						
Vcc	50 Hz to 3400 Hz	-1*	25 30	45 45			6, 7
	3.4 kHz to 50 kHz	-1*	22 25	35 35			0, 1
V _{EE}	50 Hz to 3400 Hz	-1*	20 25	40 40		dB	6, 7
	3.4 kHz to 50 kHz	-1*	10 10	25 25		u.b	0, 1
V_{BAT}	50 Hz to 3400 Hz	-1*	27 30	45 45			6, 7
	3.4 kHz to 50 kHz	-1*	20 25	40 40			0, 1
Off-Hook Detector							
Current threshold accuracy	I _{DET} = 365/R _D Nominal		-20		+20	%	
Ground-Key Detector Thresho	olds, Active State, BAT = -48 V (See	Test Ci	rcuit F)				
Ground-key resistance threshold	B(RING) to GND		2.0	5.0	10.0	kΩ	
Ground-key current threshold	B(RING) to GND Midpoint to GND			9 9		mA	8
Ring-Trip Detector Input		•					
Bias current			- 5	-0.05		μΑ	
Offset voltage	Source resistance 0 to 2 $M\Omega$		-50	0	+50	mV	13

ELECTRICAL CHARACTERISTICS (CONTINUED)

Description	Test Conditions (See Note 1)	Min	Тур	Max	Unit	Note		
Logic Inputs (C4-C1, E0, E	Logic Inputs (C4–C1, E0, E1, and CHCLK)							
Input High voltage		2.0			V			
Input Low voltage				0.8	ļ ^v			
Input High current	All inputs except E1	-75		40				
Input High current	Input E1	-75		45	μΑ			
Input Low current		-0.4			mA			
Logic Output (DET)		•						
Output Low voltage	I _{OUT} = 0.8 mA			0.4	V			
Output High voltage	I _{OUT} = -0.1 mA	2.4			ľ			
Relay Driver Outputs (RING	Relay Driver Outputs (RINGOUT, TESTOUT)							
On voltage	50 mA source	BGND -2	BGND -0.95		V			
Off leakage			0.5	100	μΑ			
Clamp voltage	50 mA sink	Q _{BAT} –2			V			

RELAY DRIVER SCHEMATICS



16857C-002

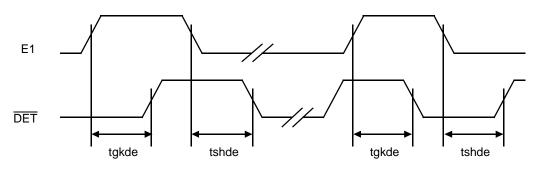
SWITCHING CHARACTERISTICS

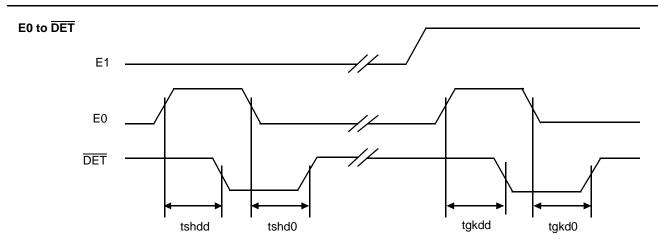
Am79M570/Am79M574

Symbol	Parameter	Test Conditions	Temperature Range	Min	Тур	Max	Unit	Note
tgkde	E1 Low to DET High (E0 = 1)		0°C to +70°C -40°C to +85°C			3.8 4.0		
igitae	E1 Low to DET Low (E0 = 1)	Ground-Key Detect state R _I open, R _G connected	0°C to +70°C -40°C to +85°C			1.1 1.6		
tgkdd	E0 High to \overline{DET} Low (E1 = 0)	(See Figure H)	0°C to +70°C -40°C to +85°C			1.1 1.6		
tgkd0	E0 Low to DET High (E1 = 0)		0°C to +70°C -40°C to +85°C			3.8 4.0		4
tshde	E1 High to DET Low (E0 = 1)		0°C to +70°C -40°C to +85°C			1.2 1.7	μs	4
	E1 High to DET High (E0 = 1)	Switchhook Detect state $R_1 = 600 \Omega$, R_G open	0°C to +70°C -40°C to +85°C			3.8 4.0		
tshdd	E0 High to DET Low (E1 = 1)	(See Figure G)	0°C to +70°C -40°C to +85°C			1.1 1.6		
tshd0	E0 Low to DET High (E1 = 1)		0°C to +70°C -40°C to +85°C			3.8 4.0		

SWITCHING WAVEFORMS Am79M570/Am79M574

E1 to DET





Note: All delays measured at 1.4 V level.

16857C-003

Notes:

- Unless otherwise noted, test conditions are BAT = -48 V, V_{CC} = +5 V, V_{EE} = -5 V, R_L = 600 Ω, C_{HP} = 0.22 μF, R_{DC1} = R_{DC2} = 20 kΩ, C_{DC} = 0.1 μF, R_d = 51.1 kΩ, no fuse resistors, two-wire AC output impedance, programming impedance (Z_T) = 306 kΩ resistive, receive input summing impedance (Z_{RX}) = 300 kΩ resistive. (See Table 2 for component formulas.)
- 2. Overload level is defined when THD = 1%.
- 3. Balance return signal is the signal generated at V_{TX} by V_{RX} . This specification assumes that the two-wire AC load impedance matches the impedance programmed by Z_T .
- 4. Not tested in production. This parameter is guaranteed by characterization or correlation to other tests.
- 5. These tests are performed with a longitudinal impedance of 90Ω and metallic impedance of 300Ω for frequencies below 12 kHz and 135 Ω for frequencies greater than 12 kHz. These tests are extremely sensitive to circuit board layout.
- 6. This parameter is tested at 1 kHz in production. Performance at other frequencies is guaranteed by characterization.
- 7. When the SLIC is in the Anti-sat 2 operating region, this parameter is degraded. The exact degradation depends on system design. The Anti-sat 2 region occurs at high loop resistances when $|V_{BAT}| |V_{AX} V_{BX}|$ is less than approximately 17V.
- 8. "Midpoint" is defined as the connection point between two 300 Ω series resistors connected between A(TIP) and B(RING).
- 9. Fundamental and harmonics from 256 kHz switch-regulator chopper are not included.
- 10. Loop-current limit which depends upon the programmed apparent open circuit voltage and the feed resistance is calculated as follows:

In OHT state:
$$I_{LIMIT} = 0.5 \frac{V_{apparent}}{R_{FEED}}$$
 In Active state: $I_{LIMIT} = 0.8 \frac{V_{apparent}}{R_{FEED}}$

- 11. Total harmonic distortion with metering as specified with a metering signal of 2.2 Vrms at the two-wire output, and a transmit signal of +3 dBm or receive signal of –4 dBm. The transmit or receive signals are single-frequency inputs, and the distortion is measured as the highest in-band harmonic at the two-wire or the four-wire output relative to the input signal.
- 12. Noise with metering is measured by applying a 2.2 Vrms metering signal (measured at the two-wire output) and measuring the psophometric noise at the two-wire and four-wire outputs over a 200 ms time interval.
- 13. Tested with 0Ω source impedance. 2 M Ω is specified for system design purposes only.
- 14. Assumes the following Z_T network:

VTX
$$\longrightarrow$$
 \longrightarrow RSN 153 k Ω \longrightarrow 153 k Ω FSN 56 pF

15. Group delay can be considerably reduced by using a Z_T network such as that shown in Note 14. The network reduces the group delay to less than 2 μ s. The effect of group delay on linecard performance may be compensated for by using the QSLACTM or DSLACTM devices.

Table 1. SLIC Decoding

			DET Output		
State	C3 C2 C1	Two-Wire Status	E0 = 1* E1 = 0	E0 = 1* E1 = 1	
0	0 0 0	Open Circuit	Ring trip	Ring trip	
1	0 0 1	Ringing	Ring trip	Ring trip	
2	0 1 0	Active	Loop detector	Ground key	
3	0 1 1	On-hook TX (OHT)	Loop detector	Ground key	
4	1 0 0	Tip Open	Loop detector	_	
5	1 0 1	Reserved	Loop detector	_	
6	1 1 0	Active Polarity Reversal	Loop detector	Ground key	
7	1 1 1	OHT Polarity Reversal	Loop detector	Ground key	

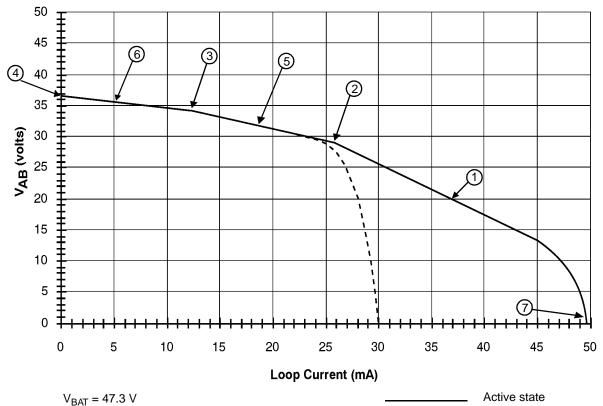
Note:

^{*}For the Am79M570 and Am79M574 logic Low on E0 disables the DET output into the open-collector state.

Table 2. User-Programmable Components

$Z_{\rm T} = 510(Z_{\rm 2WIN} - 2R_{\rm F})$	Z_{T} is connected between the VTX and RSN pins. The fuse resistors are R_{F} and Z_{2WIN} is the desired 2-wire AC input impedance. When computing Z_{T} , the internal current amplifier pole and any external stray capacitance between VTX and RSN must be taken into account.
$Z_{RX} = \frac{Z_{L}}{G_{42L}} \bullet \frac{1000 \bullet Z_{T}}{Z_{T} + 510(Z_{L} + 2R_{F})}$	Z_{RX} is connected from V_{RX} to the RSN pin, Z_T is defined above, and G_{42L} is the desired receive gain.
$R_{DCI} + R_{DC2} = 50(R_{FEED} - 2R_F)$ $C_{DC} = 1.5 \text{ ms} \bullet \frac{R_{DC1} + R_{DC2}}{R_{DC1} \bullet R_{DC2}}$	$R_{DC1},R_{DC2},\text{and}C_{DC}$ form the network connected to the RDC pin. R_{DC1} and R_{DC2} are approximately equal.
$R_{\rm D} = \frac{365}{I_{\rm T}}, C_{\rm D} = \frac{0.5 \text{ ms}}{R_{\rm D}}$	R_{D} and C_{D} form the network connected from RD to -5 V and I_{T} is the threshold current between on-hook and off-hook.
$Z_{M} = \frac{V_{MG}}{V_{M2W}} \bullet \frac{K_{1}(\omega)Z_{L} \bullet Z_{T}}{Z_{T} + 0.51 \bullet K_{1}(\omega)(2R_{F} + Z_{L})}$	$\begin{split} Z_M \text{ is connected from V}_{MG} \text{ (metering source) to the RSN pin, V}_{M2W} \text{ is the desired magnitude of the metering signal at the 2-wire output (usually 2.2 Vrms) and K}_1(\omega) \text{ is defined below.} \\ K_1(\omega) &= \frac{1000}{1+j\omega(11.5 \bullet 10^{-9} + CX/2)(36 + Z_L + 2R_F)} \\ \text{where: CX = The values of the identical capacitors from A and B to GND} \\ \omega &= 2\pi \bullet \text{metering frequency} \end{split}$

DC FEED CHARACTERISTICS



 $R_{DC} = 40 \text{ k}\Omega$

_____ Active state

Notes:

1. Constant-resistance region:
$$V_{AB} = 50 - I_{L} \frac{R_{DC}}{50}$$

2. Anti-sat-1 turn-on: $V_{AB} = 28.48 \text{ V}$

3. Anti-sat-2 turn-on: $V_{AB} = 0.992 |V_{BAT}| - 13.8$

4. Open Circuit voltage: $V_{AB} = 0.44 \left| V_{BAT} \right| + 15.89$, $\left| V_{BAT} \right| < 52.2 \text{ V (Anti-sat -2)}$

 $V_{AB} = 38.85 \text{ V}, \qquad |V_{BAT}| \ge 52.2 \text{ V (Anti-sat -1)}$

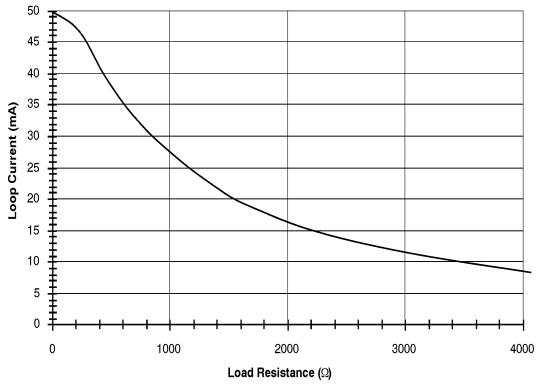
5. Anti-sat –1 region: $V_{AB} = 38.85 - I_L \frac{R_{DC}}{101.3}$

6. Anti-sat –2 region: $V_{AB} = 0.44 |V_{BAT}| + 15.89 - I_L \frac{R_{DC}}{173.9}$

7. Current limit: $I_L = \frac{1992}{R_{DC}}$

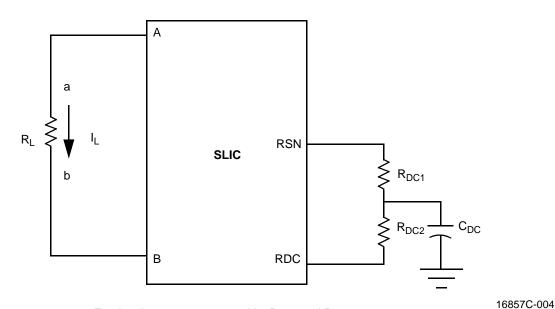
a. V_A-V_B (V_{AB}) Voltage vs. Loop Current (Typical)

DC FEED CHARACTERISTICS (CONTINUED)



 $V_{BAT} = 47.3 \text{ V}$ $R_{DC} = 40 \text{ k}\Omega$

b. Loop Current vs. Load Resistance (Typical)

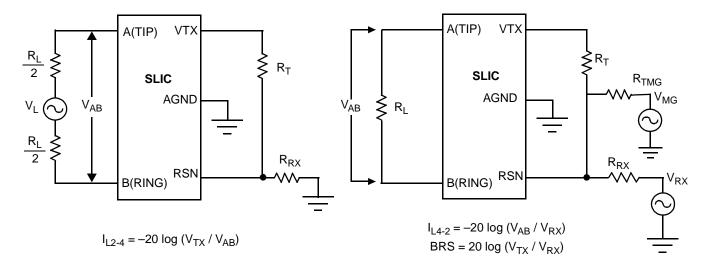


Feed resistance programmed by R_{DC1} and R_{DC2}

c. Feed Programming

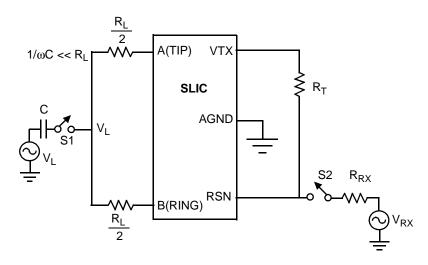
Figure 1. DC Feed Characteristics

TEST CIRCUITS



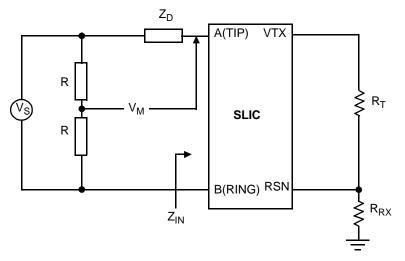
A. Two- to Four-Wire Insertion Loss

B. Four- to Two-Wire Insertion Loss and Balance Return Signal



S1 Closed, S2 Open L-T Long. Bal. = $-20 \log (V_{AB} / V_L)$ L-4 Long. Bal. = $-20 \log (V_{TX} / G_{TX} \bullet V_L)$

C. Longitudinal Balance



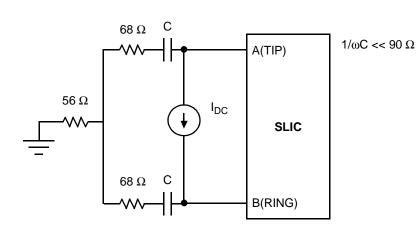
Note:

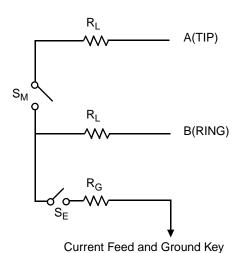
 Z_D is the desired impedance (i.e., the characteristic impedance of the line).

 $R_L = 20 \log (2 V_M / V_S)$

D. Two-Wire Return Loss Test Circuit

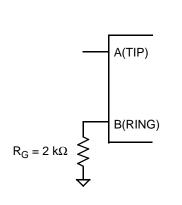
TEST CIRCUITS (CONTINUED)



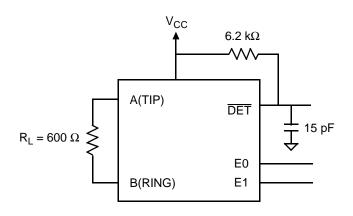


E. Single-Frequency Noise

F. Ground-Key Detection







H. Loop-Detector Switching

REVISION SUMMARY

Revision B to C

Minor changes were made to the data sheet style and format to conform to AMD standards.

Revision C to D

- In Pin Description table, inserted/changed TP pin description to: "Thermal pin. Connection for heat dissipation. Internally connected to substrate (QBAT). Leave as open circuit or connected to QBAT. In both cases, the TP pins can connect to an area of copper on the board to enhance heat dissipation."
- Minor changes were made to the data sheet style and format to conform to AMD standards.

Trademarks

Copyright © 1998 Advanced Micro Devices, All rights reserved.

AMD, the AMD logo and combinations thereof are trademarks of Advanced Micro Devices, Inc.

DSLAC and QSLAC are trademarks of Advanced Micro Devices, Inc.

Product names used in this publication are for identification purposes only and may be trademarks of their respective companies.